

# NSRLL30XV2

## Schottky Barrier Diode

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

### Features

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.6 V (max) @  $I_F = 200$  mA
- Low Reverse Current
- ESD Rating: Class 3B per Human Body Model  
Class C per Machine Model
- This is a Pb-Free Device

### MAXIMUM RATINGS

| Rating             | Symbol | Value | Unit |
|--------------------|--------|-------|------|
| Reverse Voltage    | $V_R$  | 30    | V    |
| Forward Current DC | $I_F$  | 200   | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS

| Characteristic   | Symbol          | Max         | Unit                      |
|--|-----------------|-------------|---------------------------|
| Total Device Dissipation FR-5 Board,<br>(Note 1) $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$           | 200         | mW                        |
|  |                 | 1.57        | mW/ $^\circ\text{C}$      |
| Non-Repetitive Peak Forward<br>Current, $t_p < 10$ msec  | $I_{FSM}$       | 600         | mA                        |
| Repetitive Peak Forward Current<br>Pulse Wave = 1 sec, Duty Cycle = 66%                                      | $I_{FRM}$       | 300         | mA                        |
| Thermal Resistance, Junction-to-Ambient  | $R_{\theta JA}$ | 635         | $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature Range   | $T_J, T_{stg}$  | -55 to +150 | $^\circ\text{C}$          |

1. FR-5 Minimum Pad.

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic                       | Symbol | Min | Typ | Max  | Unit          |
|--------------------------------------|--------|-----|-----|------|---------------|
| Reverse Leakage<br>( $V_R = 10$ V)   | $I_R$  | -   | -   | 1.0  | $\mu\text{A}$ |
| Forward Voltage<br>( $I_F = 200$ mA) | $V_F$  | -   | -   | 0.60 | V             |



ON Semiconductor®

[www.onsemi.com](http://www.onsemi.com)

## 30 VOLT SCHOTTKY BARRIER DIODE



SOD-523  
CASE 502

### MARKING DIAGRAM



RT = Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation position may vary depending upon manufacturing location.

### ORDERING INFORMATION

| Device        | Package              | Shipping†        |
|---------------|----------------------|------------------|
| NSRLL30XV2T1G | SOD-523<br>(Pb-Free) | 3000/Tape & Reel |
| NSRLL30XV2T5G | SOD-523<br>(Pb-Free) | 8000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NSRLL30XV2

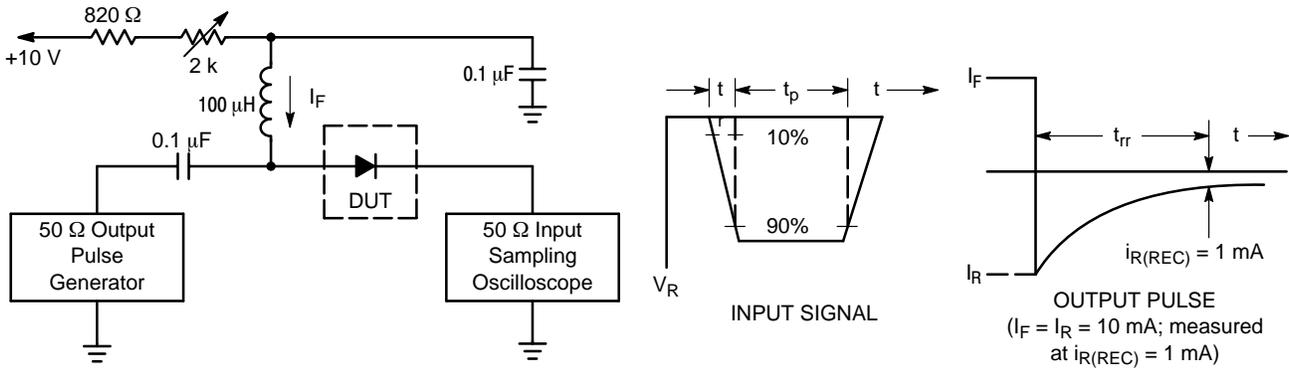


Figure 1. Recovery Time Equivalent Test Circuit

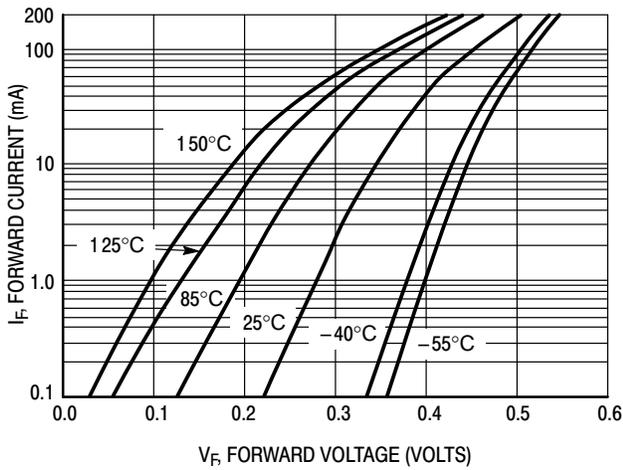


Figure 2. Forward Voltage

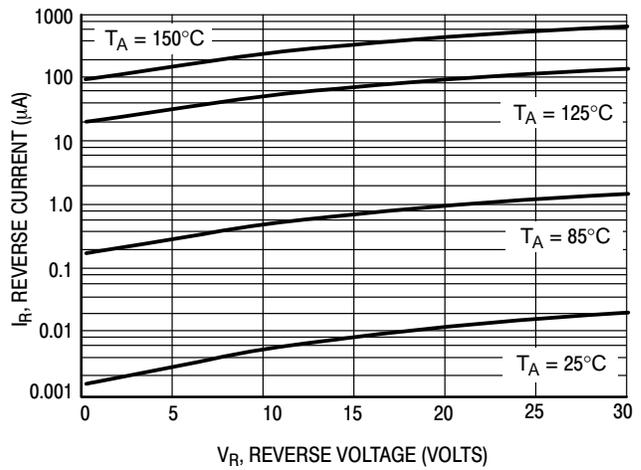


Figure 3. Leakage Current

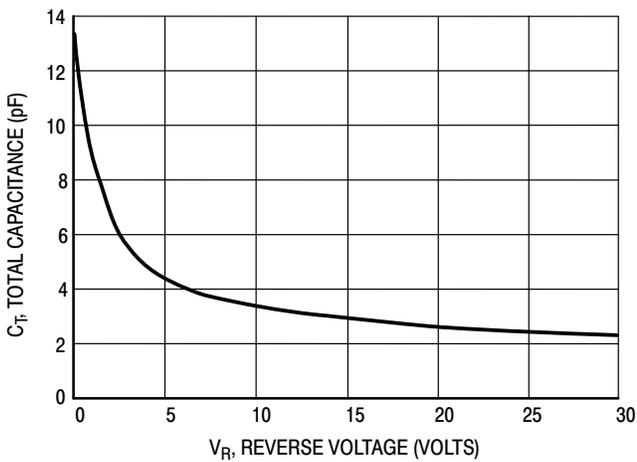


Figure 4. Total Capacitance

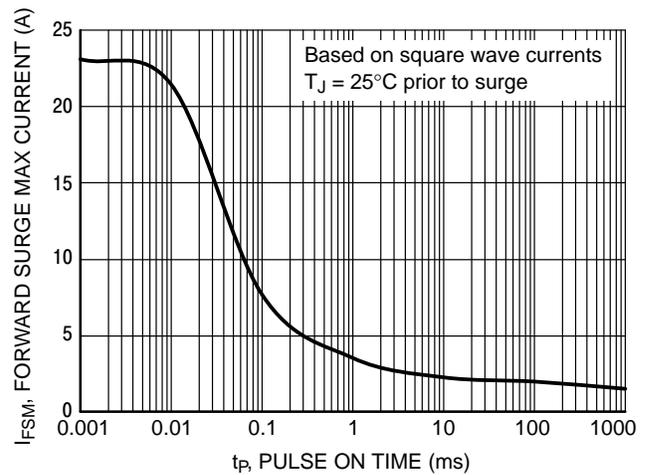
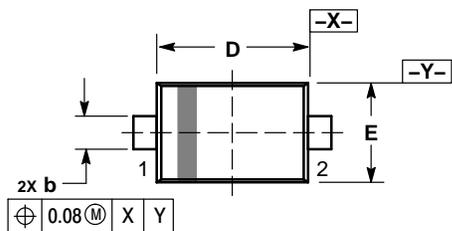


Figure 5. Forward Surge Current

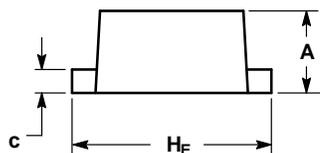
# NSRLL30XV2

## PACKAGE DIMENSIONS

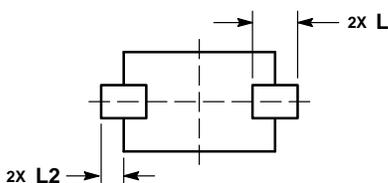
SOD-523  
CASE 502  
ISSUE E



TOP VIEW



SIDE VIEW



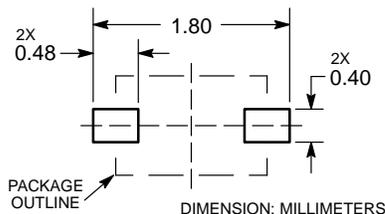
BOTTOM VIEW

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| DIM            | MILLIMETERS |      |      |
|----------------|-------------|------|------|
|                | MIN         | NOM  | MAX  |
| A              | 0.50        | 0.60 | 0.70 |
| b              | 0.25        | 0.30 | 0.35 |
| c              | 0.07        | 0.14 | 0.20 |
| D              | 1.10        | 1.20 | 1.30 |
| E              | 0.70        | 0.80 | 0.90 |
| H <sub>E</sub> | 1.50        | 1.60 | 1.70 |
| L              | 0.30 REF    |      |      |
| L2             | 0.15        | 0.20 | 0.25 |

### RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

N. American Technical Support: 800-282-9855 Toll Free  
USA/Canada  
Europe, Middle East and Africa Technical Support:  
Phone: 421 33 790 2910

ON Semiconductor Website: [www.onsemi.com](http://www.onsemi.com)  
Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[NSRLL30XV2T1G](#) [NSRLL30XV2T5G](#)